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## HUFA76413DK8T\_F085 N-Channel Logic Level UltraFET<sup>®</sup> Power MOSFET **60V, 4.8A, 56m**Ω

#### **General Description**

These N-Channel power MOSFETs are manufactured using the innovative UltraFET® process. This advanced process technology achieves the lowest possible onresistance per silicon area, resulting in outstanding performance. This device is capable of withstanding high energy

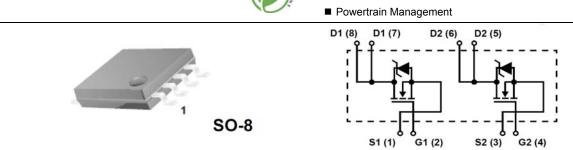
in the avalanche mode and the diode exhibits very low reverse recovery time and stored charge. It was designed for use in applications where power efficiency is important, such as switching regulators, switching convertors, motor drivers, relay drivers, low-voltage bus switches, and power management in portable and battery-operated products.

#### Features

- 150°C Maximum Junction Temperature
- UIS Capability (Single Pulse and Repetitive Pulse)
- Ultra-Low On-Resistance r<sub>DS(ON)</sub> = 0.049Ω, VGS = 10V
- Ultra-Low On-Resistance r<sub>DS(ON)</sub> = 0.056Ω, VGS = 5V
- Qualified to AEC Q101
- RoHS Compliant

#### Applications

Motor and Load Control



#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V <sub>DSS</sub>	Drain to Source Voltage	60	V	
V <sub>GS</sub>	Gate to Source Voltage	±16	V	
	Drain Current -Continuous (T <sub>C</sub> = 25 °C, V <sub>GS</sub> = 10V)	5.1		
	-Continuous (T <sub>C</sub> = 25 °C, V <sub>GS</sub> = 5V)	4.8	Α	
ID	-Continuous (T <sub>C</sub> = 125 °C, V <sub>GS</sub> = 5V, R <sub>0JA</sub> = 228°C/W)	1		
	-Pulsed	Figure 4		
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 1)	260	mJ	
P <sub>D</sub>	Power Dissipation	2.5	W	
	Derate Above 25 °C	0.02	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature	-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ hetaJA}$	Thermal Resistance Junction to Ambient SO-8 (Note 2)	50	
	Thermal Resistance Junction to Ambient SO-8 (Note 3)	191	°C/W
	Thermal Resistance Junction to Ambient SO-8 (Note 4)	228	

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
76413DK8	HUFA76413DK8T_F085	SO-8	330mm	12mm	2500 units
Notes:					

1: Starting T<sub>J</sub> = 25 °C, L = 20mH, I<sub>AS</sub> = 5.1A

2:  $R_{\theta JA}$  is 50 °C/W when mounted on a 0.5 in<sup>2</sup> copper pad on FR-4 at 1 second.

**3:**  $R_{\theta JA}^{\circ}$  is 191 °C/W when mounted on a 0.027 in<sup>2</sup> copper pad on FR-4 at 1000 seconds. **4:**  $R_{\theta JA}^{\circ}$  is 228 °C/W when mounted on a 0.006 in<sup>2</sup> copper pad on FR-4 at 1000 seconds.

5: A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced in Aug 2014.

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V		60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 55 V, V <sub>GS</sub> = 0 V	T <sub>A</sub> = 150 °C	-	-	1 250	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±16 V		-	-	±100	nA
	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA		1	-	3	V
00(11)	5	$I_{\rm D} = 5.1  \text{A},  V_{\rm GS} = 10  \text{V}$		-	0.041	0.049	Ω
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$I_{\rm D} = 4.8 \text{ A}, V_{\rm GS} = 5 \text{ V}$		-	0.048	0.056	
DO(011)		$I_{\rm D}$ = 4.8 A, $V_{\rm GS}$ =		-	0.091	0.106	
C <sub>iss</sub>	Characteristics Input Capacitance Output Capacitance	$V_{DS} = 25 V, V_{GS} = 0 V,$ f = 1MHz		-	620	-	pF
C <sub>oss</sub>	Output Capacitance			-	180	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	30	-	pF
Q <sub>g(TOT)</sub>	Total Gate Charge at 10V	$V_{GS} = 0$ to 10 V		-	18	23	nC
Q <sub>g(5)</sub>	Total Gate Charge at 5V	$V_{GS} = 0$ to 5 V	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 4.8 A,	-	10 0.6	13 0.8	nC nC
Q <sub>g(TH)</sub>	Threshold Gate Charge Gate to Source Charge	$V_{GS}$ = 0 to 1 V	$I_D = 4.8 \text{ A},$ $I_a = 1.0 \text{ mA}$	-	1.8	0.0	nC
Q <sub>gs</sub>	Gate to Drain "Miller" Charge		ig no in t	-	5	-	nC
Q <sub>gd</sub>	Gate to Drain Miller Charge			-	5	-	no
Switching	g Characteristics (V <sub>GS</sub> =5V)						
t <sub>on</sub>	Turn-On Time			-	-	44	ns
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 1.0 A, V <sub>GS</sub> = 5 V, R <sub>GS</sub> = 16 Ω		-	10	-	ns
t <sub>r</sub>	Rise Time			-	19	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			-	45	-	ns
t <sub>f</sub>	Fall Time			-	27	-	ns
t <sub>off</sub>	Turn-Off Time				1	108	ns

#### **Drain-Source Diode Characteristics**

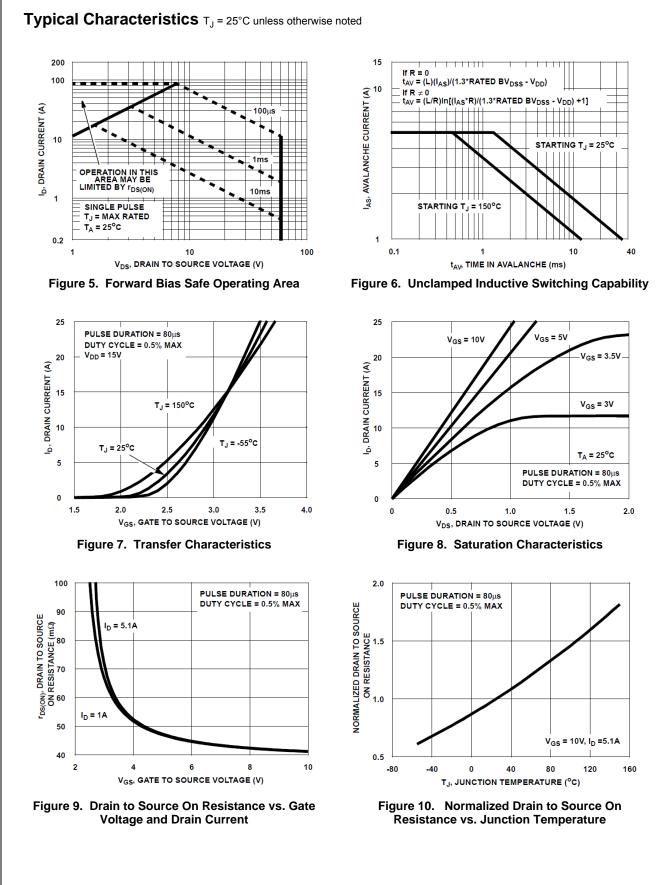
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	I <sub>SD</sub> = 4.8 A	-	-	1.25	1.25 V 1.0	
		I <sub>SD</sub> = 2.4 A	-	-	1.0		
t <sub>rr</sub>	Reverse Recovery Time	I <sub>SD</sub> = 4.8 A, dI <sub>SD</sub> /dt = 100 A/μs	-	-	43	ns	
Q <sub>rr</sub>	Reverse Recovery Charge		-	-	55	nC	



#### 6 1.2 POWER DISSIPATION MULTIPLIER 1.0 V<sub>GS</sub> = 10V, R<sub>0JA</sub>=50°C/W -I<sub>D</sub>, DRAIN CURRENT (A) 0.8 4 0.6 0.4 2 0.2 V<sub>GS</sub> = 5V, R<sub>0JA</sub>=228°C/W 0 0 25 75 100 150 0 50 125 25 50 75 100 125 150 TA, AMBIENT TEMPERATURE (°C) TA, CASE TEMPERATURE (°C) Figure 1. Normalized Power Dissipation vs. Ambient Figure 2. Maximum Continuous Drain Current vs. Temperature **Case Temperature** DUTY CYCLE - DESCENDING ORDER 4 1 R<sub>0JA</sub>=50°C/W 0.1 Z<sub>0JA</sub>, NORMALIZED THERMAL IMPEDANCE 0.05 +++++++ 0.02 ۲ 0.01 0.1 P<sub>DM</sub> V<sub>GS</sub> = 10V t₁ 0.01 NOTES: DUTY FACTOR: D = t<sub>1</sub>/t<sub>2</sub> SINGLE PULSE PEAK $T_J = P_{DM} \times Z_{\theta JA} \times R_{\theta JA} + T_A$ 0.001 ..... 10<sup>-5</sup> 10<sup>-4</sup> 10<sup>-3</sup> 10<sup>-2</sup> 10<sup>-1</sup> 10<sup>0</sup> 10<sup>1</sup> 10<sup>2</sup> 10<sup>3</sup> t, RECTANGULAR PULSE DURATION (s) Figure 3. Normalized Maximum Transient Thermal Impedance 300 T<sub>A</sub> = 25°C R<sub>0JA</sub>=50°C/W TRANSCONDUCTANCE MAY LIMIT CURRENT IN THIS REGION FOR TEMPERATURES ABOVE 25°C DERATE PEAK 100 ł IDM, PEAK CURRENT (A) CURRENT AS FOLLOWS: 175 **- T**A $V_{GS} = 5V$ 1<sub>25</sub> 150 TT NHH V<sub>GS</sub> = 10V 10 2 10<sup>-5</sup> 10<sup>-3</sup> 10<sup>-4</sup> 10<sup>-2</sup> 10<sup>0</sup> 10<sup>1</sup> 10<sup>2</sup> 10<sup>-1</sup> 10<sup>3</sup> t, PULSE WIDTH (s) Figure 4. Peak Current Capability

### Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

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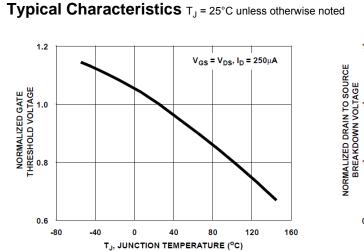


Figure 11. Normalized Gate Threshold Voltage vs. Junction Temperature

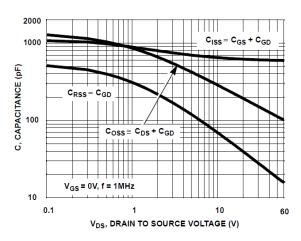
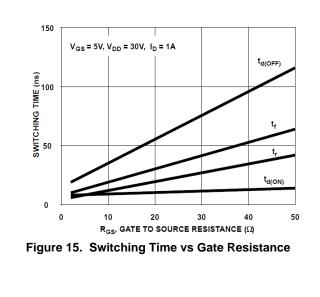


Figure 13. Capacitance vs. Drain to Source Voltage



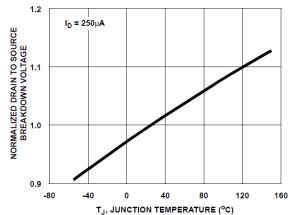


Figure 12. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

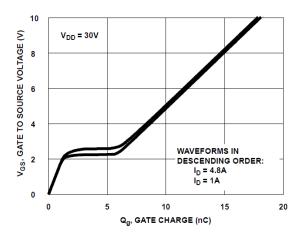
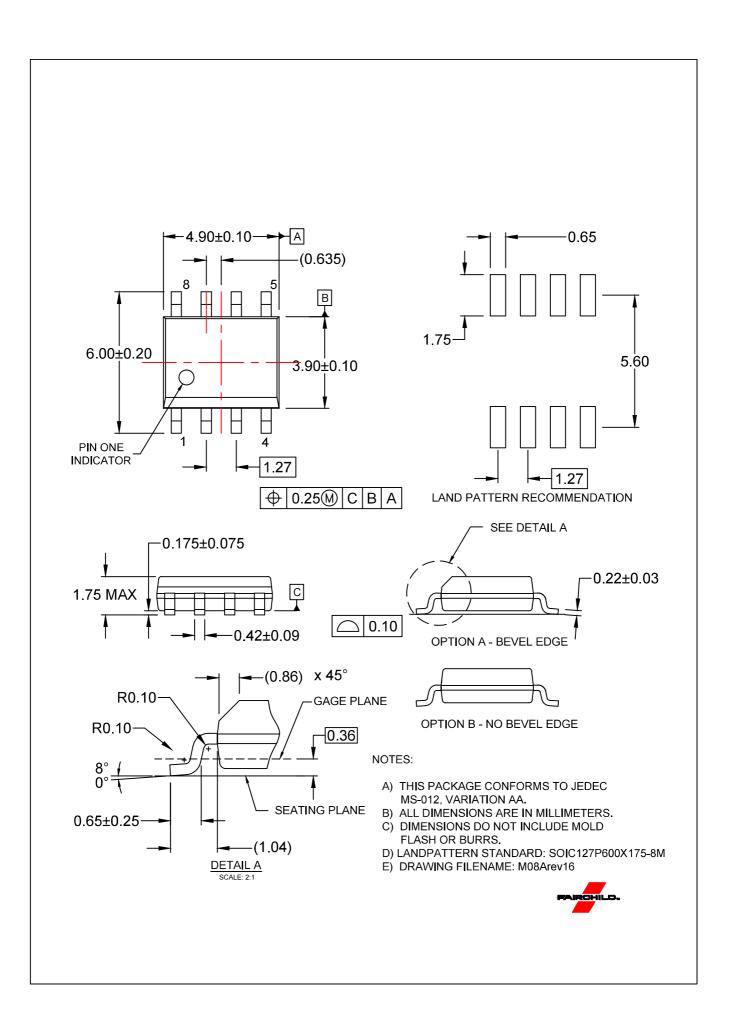


Figure 14. Gate Charge Waveforms for Constant Gate Currents



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